**Product data sheet** 

# 1. General description

Passivated sensitive gate Silicon Controlled Rectifier (SCR) in a SOT428 (DPAK) surface mountable plastic package intended for use in applications requiring high bidirectional blocking voltage capability and high thermal cycling performance. These devices are intended to be interfaced directly to microcontrollers, logic integrated circuits and other low power gate trigger circuits.

### 2. Features and benefits

- Direct interfacing with low power drivers and microcontrollers
- High bidirectional blocking voltage capability
- High junction operating temperature capability
- · High thermal cycling performance
- Planar passivated for voltage ruggedness and reliability
- Surface mountable package
- Very sensitive gate for logic level controls

## 3. Applications

- General purpose switching and phase control
- Ignition circuits, CDI for 2- and 3-wheelers
- Motor control e.g. small kitchen appliances
- Protection circuits for Switched-Mode Power Supplies (SMPS)
- Protection circuits in lighting ballasts

## 4. Quick reference data

Table 1. Quick reference data

| Symbol                 | Parameter                                | Conditions   |     | Min | Тур | Max | Unit |
|------------------------|--|--|-----|-----|-----|-----|------|
| $V_{RRM}$              | repetitive peak reverse voltage          |  |     | -   | -   | 800 | V    |
| I <sub>T(AV)</sub>     | average on-state current                 | half sine wave; $T_{mb} \le 135 ^{\circ}\text{C}$ ; Fig. 1                                     |     | -   | -   | 5   | A    |
| I <sub>T(RMS)</sub>    | RMS on-state current                     | half sine wave; $T_{mb} \le 135 ^{\circ}\text{C}$ ; Fig. 2; Fig. 3                             |     | -   | -   | 8   | A    |
| I <sub>TSM</sub>       | non-repetitive peak on-<br>state current | half sine wave; $T_{j(init)} = 25 \text{ °C}$ ;<br>$t_p = 10 \text{ ms}$ ; $Fig. 4$ ; $Fig. 5$ |     | -   | -   | 75  | A    |
|                        |  | half sine wave; $T_{j(init)}$ = 25 °C;<br>$t_p$ = 8.3 ms                                       |     | -   | -   | 82  | A    |
| Tj                     | junction temperature                     |  | [1] | -   | -   | 150 | °C   |
| Static characteristics |  |  |     |     |     |     |      |

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| Symbol              | Parameter                         | Conditions  |  | Min | Тур | Max | Unit |
|---------------------|-----------------------------------|---|--|-----|-----|-----|------|
| I <sub>GT</sub>     | gate trigger current              | $V_D = 12 \text{ V}; I_T = 0.1 \text{ A}; T_j = 25 \text{ °C}; Fig. 8$  |  | 20  | -   | 50  | μA   |
| Dynamic chara       | Dynamic characteristics           |   |  |     |     |     |      |
| dV <sub>D</sub> /dt | rate of rise of off-state voltage | $V_{DM}$ = 536 V; $T_j$ = 150 °C; $R_{GK}$ = 100 Ω; $(V_{DM}$ = 67% of $V_{DRM}$ ); exponential waveform; Fig. 13 |  | 35  | 70  | -   | V/µs |

<sup>[1]</sup> Operation above junction temperatures of 110  $^{\circ}$ C may require the use of a gate to cathode resistor of 1 k $\Omega$  or less.

# 5. Pinning information

## **Table 2. Pinning information**

| Pin | Symbol | Description                       | Simplified outline | Graphic symbol       |
|-----|--------|-----------------------------------|--------------------|----------------------|
| 1   | K      | cathode                           |                    | А <del>-    </del> К |
| 2   | Α      | anode                             |                    | G<br>sym037          |
| 3   | G      | gate                              |                    | Symoch               |
| mb  | Α      | mounting base; connected to anode | DPAK (SOT428)      |                      |

# 6. Ordering information

### **Table 3. Ordering information**

| Type number  | Package |   |         |
|--------------|---------|---|---------|
|              | Name    | Description   | Version |
| BT258S-800LT | DPAK    | plastic single-ended surface-mounted package (DPAK); 3 leads (one lead cropped) | SOT428  |

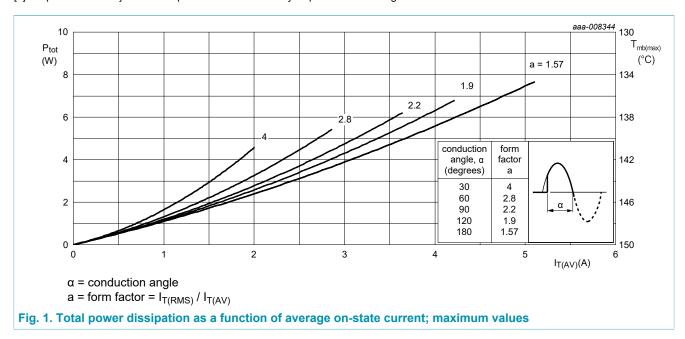
# 7. Limiting values

### **Table 4. Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol              | Parameter                                | Conditions  |     | Min | Max | Unit |
|---------------------|--|---|-----|-----|-----|------|
| $V_{DRM}$           | repetitive peak off-state voltage        |   |     | -   | 800 | V    |
| $V_{RRM}$           | repetitive peak reverse voltage          |   |     | -   | 800 | V    |
| I <sub>T(AV)</sub>  | average on-state current                 | half sine wave; T <sub>mb</sub> ≤ 135 °C; <u>Fig. 1</u>               |     | -   | 5   | Α    |
| I <sub>T(RMS)</sub> | RMS on-state current                     | half sine wave; $T_{mb} \le 135 ^{\circ}\text{C}$ ; Fig. 2; Fig. 3    |     | -   | 8   | Α    |
| I <sub>TSM</sub>    | non-repetitive peak on-<br>state current | half sine wave; $T_{j(init)}$ = 25 °C; $t_p$ = 10 ms; Fig. 4; Fig. 5  |     | -   | 75  | А    |
|                     |  | half sine wave; T <sub>j(init)</sub> = 25 °C; t <sub>p</sub> = 8.3 ms |     | -   | 82  | Α    |
| l <sup>2</sup> t    | I <sup>2</sup> t for fusing              | t <sub>p</sub> = 10 ms; sine-wave pulse                               |     | -   | 28  | A²s  |
| dl <sub>T</sub> /dt | rate of rise of on-state current         | I <sub>G</sub> = 50 mA  |     | -   | 50  | A/µs |
| $I_{GM}$            | peak gate current                        |   |     | -   | 2   | Α    |
| $P_{GM}$            | peak gate power                          |   |     | -   | 5   | W    |
| P <sub>G(AV)</sub>  | average gate power                       | over any 20 ms period   |     | -   | 0.5 | W    |
| T <sub>stg</sub>    | storage temperature                      |   |     | -40 | 150 | °C   |
| Tj                  | junction temperature                     |   | [1] | -   | 150 | °C   |

[1] Operation above junction temperatures of 110  $^{\circ}$ C may require the use of a gate to cathode resistor of 1 k $\Omega$  or less.



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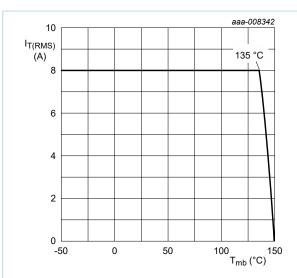


Fig. 2. RMS on-state current as a function of mounting base temperature; maximum values

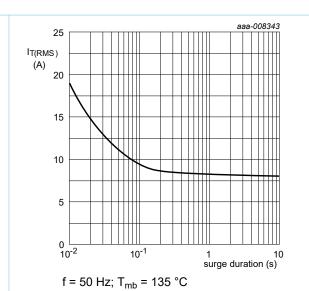


Fig. 3. RMS on-state current as a function of surge duration; maximum values

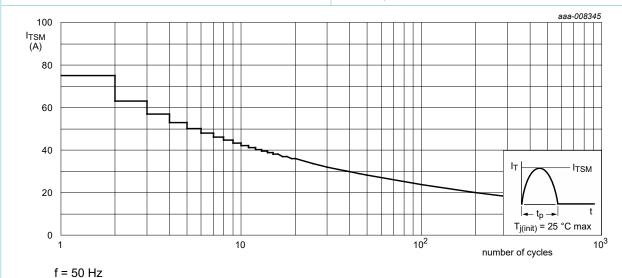
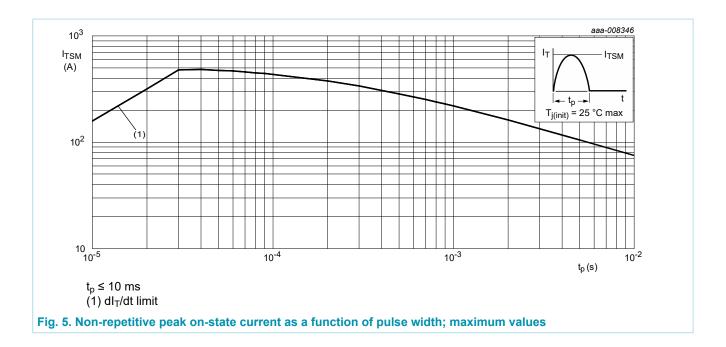


Fig. 4. Non-repetitive peak on-state current as a function of the number of sinusoidal current cycles; maximum values

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## 8. Thermal characteristics

**Table 5. Thermal characteristics** 

| Symbol                | Parameter  | Conditions  | Min | Тур | Max | Unit |
|-----------------------|--|---|-----|-----|-----|------|
| R <sub>th(j-mb)</sub> | thermal resistance<br>from junction to<br>mounting base    | Fig. 6  | -   | -   | 2   | K/W  |
| R <sub>th(j-a)</sub>  | thermal resistance<br>from junction to<br>ambient free air | Device mounted on a FR4 printed-<br>circuit board, single-sided copper, tin-<br>plated and standard footprint; Fig. 7 | -   | 75  | -   | K/W  |

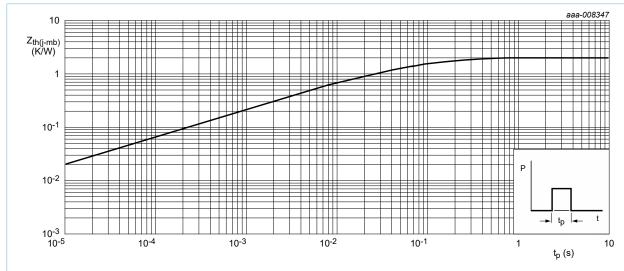
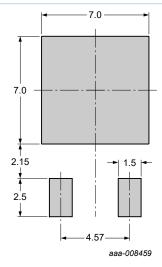


Fig. 6. Transient thermal impedance from junction to mounting base as a function of pulse width



All dimensions are in mm

Plastic meets requirements of UL94 V-O at 3.175 mm

Fig. 7. SOT428: minimum pad sizes for surface-mounting

## 9. Characteristics

Table 6. Characteristics

| Symbol              | Parameter                         | Conditions   | Notes | Min | Тур | Max | Unit |
|---------------------|-----------------------------------|--|-------|-----|-----|-----|------|
| Static cha          | aracteristics                     |  |       |     |     |     |      |
| I <sub>GT</sub>     | gate trigger current              | $V_D = 12 \text{ V}; I_T = 0.1 \text{ A}; T_j = 25 \text{ °C};$<br>Fig. 8  |       | 20  | -   | 50  | μΑ   |
| I <sub>L</sub>      | latching current                  | $V_D = 12 \text{ V}; I_G = 0.1 \text{ A}; T_j = 25 \text{ °C}; Fig. 9$   |       | -   | 0.4 | 10  | mA   |
| I <sub>H</sub>      | holding current                   | V <sub>D</sub> = 12 V; T <sub>j</sub> = 25 °C; <u>Fig. 10</u>  |       | -   | 0.3 | 6   | mA   |
| V <sub>T</sub>      | on-state voltage                  | I <sub>T</sub> = 16 A; T <sub>j</sub> = 25 °C; <u>Fig. 11</u>  |       | -   | 1.3 | 1.6 | V    |
| $V_{GT}$            | gate trigger voltage              | $V_D = 12 \text{ V}; I_T = 0.1 \text{ A}; T_j = 25 \text{ °C}; Fig. 12$  |       | -   | 0.4 | 1   | V    |
|                     |                                   | $V_D = 800 \text{ V}; I_T = 0.1 \text{ A}; T_j = 110 \text{ °C}; Fig. 12$  |       | 0.1 | 0.2 | -   | V    |
| I <sub>D</sub>      | off-state current                 | V <sub>D</sub> = 800 V; T <sub>j</sub> = 25 °C   |       | -   | -   | 10  | μA   |
|                     |                                   | V <sub>D</sub> = 800 V; T <sub>j</sub> = 150 °C  |       | -   | 0.5 | 2.5 | mA   |
| I <sub>R</sub>      | reverse current                   | V <sub>D</sub> = 800 V; T <sub>j</sub> = 25 °C   |       | -   | -   | 10  | μA   |
|                     |                                   | V <sub>D</sub> = 800 V; T <sub>j</sub> = 150 °C  |       | -   | 0.5 | 2.5 | mA   |
| Dynamic             | characteristics                   |  |       |     |     | '   |      |
| dV <sub>D</sub> /dt | rate of rise of off-state voltage | V <sub>DM</sub> = 536 V; T <sub>j</sub> = 150 °C; R <sub>GK</sub> = 100 $\Omega$ ; (V <sub>DM</sub> = 67% of V <sub>DRM</sub> ); exponential waveform; Fig. 13 |       | 35  | 70  | -   | V/µs |
| t <sub>gt</sub>     | gate-controlled turn-on time      | $I_{TM} = 10 \text{ A}; V_D = 800 \text{ V}; I_G = 5\text{mA};$<br>$dI_G/dt = 0.2\text{A}/\mu\text{s}; T_j = 25 ^{\circ}\text{C}$                              |       | -   | 2   | -   | μs   |

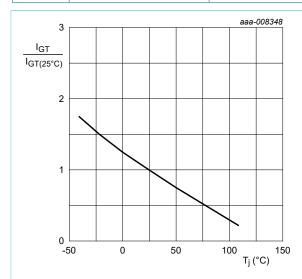


Fig. 8. Normalized gate trigger current as a function of junction temperature

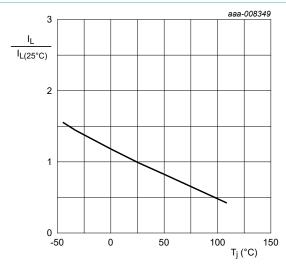


Fig. 9. Normalized latching current as a function of junction temperature

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### SCR logic level, high temperature

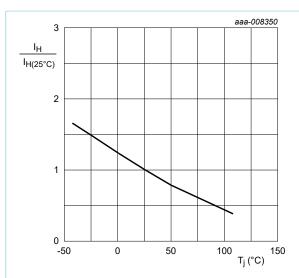
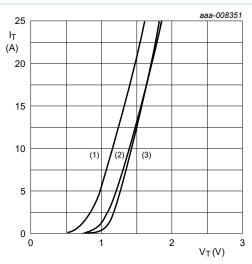


Fig. 10. Normalized holding current as a function of junction temperature



 $V_o = 0.984 \text{ V}; R_s = 0.0383 \Omega$ 

(1)  $T_j = 150$  °C; typical values (2)  $T_j = 150$  °C; maximum values

(3) T<sub>i</sub> = 25 °C; maximum values

Fig. 11. On-state current as a function of on-state voltage

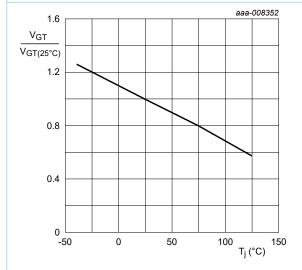


Fig. 12. Normalized gate trigger voltage as a function of junction temperature

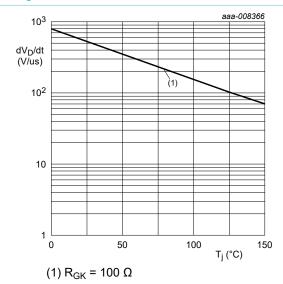
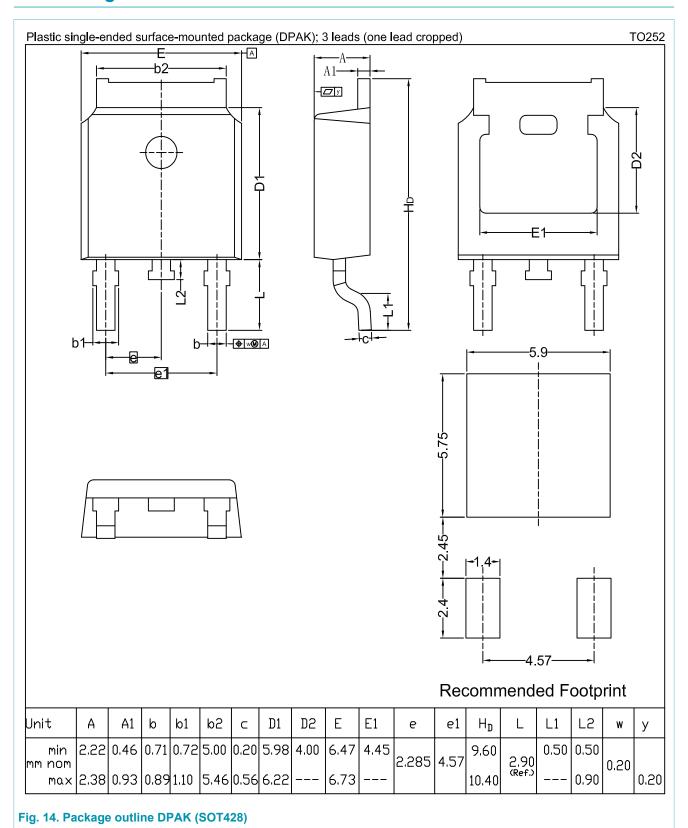


Fig. 13. Critical rate of rise of off-state voltage as a function of junction temperature; typical values

## 10. Package outline



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## 11. Legal information

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|--------------------------------------|--------------------|---|
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